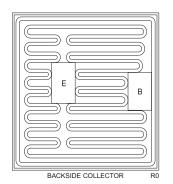


### CP219-2N5339

R0 (10-February 2016)

## NPN - Power Transistor Die 5.0 Amp, 100 Volt

The CP219-2N5339 is a silicon NPN epitaxial base power transistor designed for power amplifier and switching power supply applications.



#### **MECHANICAL SPECIFICATIONS:**

Die Size	83 x 83 MILS
Die Thickness	11 MILS
Base Bonding Pad Size	13.2 x 19.7 MILS
Emitter Bonding Pad Size	13.2 x 21.2 MILS
Top Side Metalization	AI - 30,000Å
Back Side Metalization	Au - 12,000Å
Scribe Alley Width	2.5 MILS
Wafer Diameter	4 INCHES
Gross Die Per Wafer	1,570

MAXIMUM RATINGS: (T <sub>A</sub> =25°C)	SYMBOL		UNITS
Collector-Base Voltage	$V_{CBO}$	100	V
Collector-Emitter Voltage	$V_{CEO}$	100	V
Emitter-Base Voltage	$V_{EBO}$	6.0	V
Continuous Collector Current	IC	5.0	Α
Continuous Base Current	ΙΒ	1.0	Α
Operating and Storage Junction Temperature	T <sub>J</sub> , T <sub>stg</sub>	-65 to +150	°C

ELECTRICAL	. CHARACTERISTICS: (T	Γ <sub>A</sub> =25°C unless otherwise noted)
SYMBOL	TEST CONDITIONS	MIN

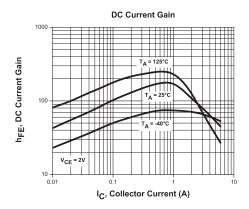
SYMBOL	TEST CONDITIONS	MIN	MAX	UNITS
I <sub>CBO</sub>	V <sub>CB</sub> =100V		10	μΑ
ICEV	$V_{CE}$ =90V, $V_{EB}$ =1.5V		10	μΑ
ICEO	V <sub>CE</sub> =90V		100	μΑ
I <sub>EBO</sub>	V <sub>EB</sub> =6.0V		100	μΑ
BV <sub>CEO</sub>	I <sub>C</sub> =50mA	100		V
V <sub>CE(SAT)</sub>	I <sub>C</sub> =2.0A, I <sub>B</sub> =200mA		0.7	V
V <sub>CE</sub> (SAT)	I <sub>C</sub> =5.0A, I <sub>B</sub> =500mA		1.2	V
V <sub>BE(SAT)</sub>	I <sub>C</sub> =2.0A, I <sub>B</sub> =200mA		1.2	V
V <sub>BE</sub> (SAT)	I <sub>C</sub> =5.0A, I <sub>B</sub> =500mA		1.8	V
h <sub>FE</sub>	$V_{CE}$ =2.0V, $I_{C}$ =500mA	60		
h <sub>FE</sub>	$V_{CE}$ =2.0V, $I_{C}$ =2.0A	60	240	
h <sub>FE</sub>	$V_{CE}$ =2.0V, $I_{C}$ =5.0A	40		
$f_{T}$	$V_{CE}$ =10V, $I_{C}$ =500mA, f=10MHz	30		MHz
$C_{ob}$	$V_{CB}$ =10V, $I_E$ =0, f=100kHz		250	pF
C <sub>ib</sub>	$V_{BE}$ =2.0V, $I_{C}$ =0, f=100kHz		1.0	nF
ton	$V_{CC}$ =40V, $I_{C}$ =2.0A, $I_{B1}$ =200mA		200	ns
$t_{S}$	$V_{CC}$ =40V, $I_{C}$ =2.0A, $I_{B1}$ = $I_{B2}$ =200mA	Λ.	2.0	μs
t <sub>f</sub>	V <sub>CC</sub> =40V, I <sub>C</sub> =2.0A, I <sub>B1</sub> =I <sub>B2</sub> =200mA	١	200	ns

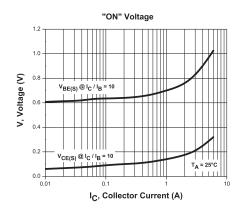
### CP219-2N5339

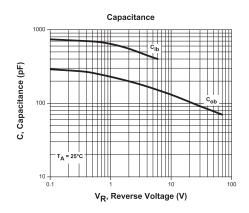
## **Typical Electrical Characteristics**

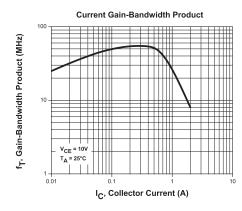


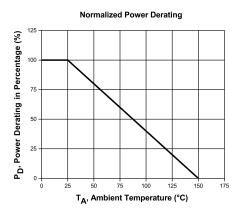
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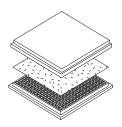






#### BARE DIE PACKING OPTIONS

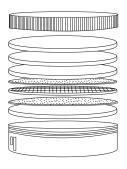




#### BARE DIE IN TRAY (WAFFLE) PACK

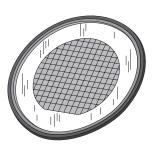
CT: Singulated die in tray (waffle) pack. (example: CP211-PART NUMBER-CT)

CM: Singulated die in tray (waffle) pack 100% visually inspected as per MIL-STD-750, (method 2072 transistors, method 2073 diodes). (example: CP211-PART NUMBER-CM)



#### **UNSAWN WAFER**

WN: Full wafer, unsawn, 100% tested with reject die inked. (example: CP211-PART NUMBER-WN)



#### SAWN WAFER ON PLASTIC RING

**WR**: Full wafer, sawn and mounted on plastic ring, 100% tested with reject die inked.

(example: CP211-PART NUMBER-WR)

Please note: Sawn Wafer on Metal Frame (WS) is possible as a special order. Please contact your Central Sales Representative at 631-435-1110.



Visit the Central website for a complete listing of specifications: www.centralsemi.com/bdspecs

R2 (3-April 2017)

#### **OUTSTANDING SUPPORT AND SUPERIOR SERVICES**



#### PRODUCT SUPPORT

Central's operations team provides the highest level of support to insure product is delivered on-time.

- Supply management (Customer portals)
- · Inventory bonding
- · Consolidated shipping options

- · Custom bar coding for shipments
- · Custom product packing

#### **DESIGNER SUPPORT/SERVICES**

Central's applications engineering team is ready to discuss your design challenges. Just ask.

- Free guick ship samples (2<sup>nd</sup> day air)
- Online technical data and parametric search
- SPICE models
- · Custom electrical curves
- · Environmental regulation compliance
- · Customer specific screening
- · Up-screening capabilities

- Special wafer diffusions
- PbSn plating options
- Package details
- Application notes
- · Application and design sample kits
- Custom product and package development

#### REQUESTING PRODUCT PLATING

- 1. If requesting Tin/Lead plated devices, add the suffix "TIN/LEAD" to the part number when ordering (example: 2N2222A TIN/LEAD).
- 2. If requesting Lead (Pb) Free plated devices, add the suffix "PBFREE" to the part number when ordering (example: 2N2222A PBFREE).

#### **CONTACT US**

#### Corporate Headquarters & Customer Support Team

Central Semiconductor Corp. 145 Adams Avenue Hauppauge, NY 11788 USA

Main Tel: (631) 435-1110 Main Fax: (631) 435-1824

Support Team Fax: (631) 435-3388

www.centralsemi.com

Worldwide Field Representatives: www.centralsemi.com/wwreps

**Worldwide Distributors:** 

www.centralsemi.com/wwdistributors

For the latest version of Central Semiconductor's **LIMITATIONS AND DAMAGES DISCLAIMER**, which is part of Central's Standard Terms and Conditions of sale, visit: <a href="https://www.centralsemi.com/terms">www.centralsemi.com/terms</a>

www.centralsemi.com (001)



# Product End of Life Notification

PDN ID:	PDN01121
Notification Date:	3/21/19
Last Buy Date:	
Last Shipment Date	Stock Only

Please be advised that Central Semiconductor must immediately discontinue the product(s) listed in the attached PDN notice. We are unable to accept any further orders for these products **unless** we have available inventory on hand.

You may have purchased one or more of the products listed. Please do not hesitate to contact your local Central Semiconductor sales representative with any questions or needs you may have. Central regrets any inconvenience this may cause.

Sincerely,

Central Semiconductor Corp.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.

CCC785 REV 002



## Product End of Life Notification

PDN ID:	PDN01121
<b>Notification Date:</b>	3/21/19
Last Buy Date:	
Last Shipment Date	Stock Only

Summary: The CP219 transistor die process is discontinued and now classified as End of Life (EOL).

Although Central Semiconductor Corp. makes every effort to continue to produce devices that have been proclaimed EOL (End of Life) by other manufacturers, it is an accepted industry practice to discontinue certain devices when customer demand falls below a minimum level of sustainability. Accordingly, the following product(s) have been transitioned to End of Life status as part of Central's ongoing Product Management Process. Any replacement products are noted below. The effective date for placing last purchase orders will be six (6) months from the date of this notice and twelve (12) months from the notice date for final shipments, and minimum order quantities may apply. The last purchase and shipment dates may be extended if inventory is available.

Central Part Number	Replacement
CP219-2N5338-WN	N/A, Stock Only
CP219-2N5339-CM	N/A, Stock Only
CP219-2N5339-CT	N/A, Stock Only
CP219-2N5339-WN	N/A, Stock Only
2N5339	N/A, Stock Only
2N5430	N/A, Stock Only

Central would be happy to assist you by providing additional information or technical data to help locate an alternate source if we have no replacement available. Please email your requests to engineering@centralsemi.com.

DISCLAIMER: This End of Life (EOL) notification is in accordance with JEDEC standard JESD48 - Product Discontinuance. Central Semiconductor Corp. will make every effort to offer life-time buy (LTB) opportunities and/or offer replacement devices to existing customers for discontinued devices, however, one or both may not be possible for all devices. Please contact your local Central Semiconductor sales representative for LTB opportunities/additional information.

CCC785 REV 002